

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KYUSEOK LEE	11/02/2018
SANGMIN HWANG	11/02/2018
SI-WOO LEE	11/02/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	MICRON TECHNOLOGY, INC.
<b>Street Address:</b>	8000 SOUTH FEDERAL WAY
<b>City:</b>	BOISE
<b>State/Country:</b>	IDAHO
<b>Postal Code:</b>	83716-9632
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16183594
<b>CORRESPONDENCE DATA</b>	
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<b>Phone:</b>	206-903-8800
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<b>Correspondent Name:</b>	DORSEY & WHITNEY LLP-IP DEPT.-MTI
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<b>ATTORNEY DOCKET NUMBER:</b>	P278732US01
<b>NAME OF SUBMITTER:</b>	DENISE SHERIDAN
<b>SIGNATURE:</b>	/Denise Sheridan/
<b>DATE SIGNED:</b>	11/07/2018
<b>Total Attachments: 3</b>	
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source=20181106_SignedAssignment_P278732US01#page3.tif	

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kyuseok Lee, Sangmin Hwang and Si-  
Woo Lee

Docket No. P278732.US.01

Disclosure No. 2018-1141.00/US

Filed : Concurrently herewith

For : APPARATUSES INCLUDING  
THRESHOLD VOLTAGE  
COMPENSATED SENSE  
AMPLIFIERS AND METHODS FOR  
COMPENSATING SAME

ASSIGNMENT :

X  Enclosed for recording

\_\_\_\_\_ Previously recorded

Date: \_\_\_\_\_

Reel: \_\_\_\_\_

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned does hereby:

SELL, ASSIGN AND TRANSFER to Micon Technology, Inc. (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83716-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled "APPARATUSES INCLUDING THRESHOLD VOLTAGE COMPENSATED SENSE AMPLIFIERS AND METHODS FOR COMPENSATING SAME"; such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Signature: Lee Kyuseok Date: Nov 02 / 2018

Assignor Name: Kyuseok Lee

Witness # 1:	
Signature: <u>[Signature]</u>	Date: <u>Nov. 02. 2018</u>
Witness Name: <u>Byung Yoon Kim</u>	
Witness # 2:	
Signature: <u>[Signature]</u>	Date: <u>Nov. 02, 2018</u>
Witness Name: <u>Jongpyo Kim</u>	

Signature: [Signature]

Date: 11/02/2018

Assignor Name: Sangmin Hwang

Witness # 1:	
Signature: <u>[Signature]</u>	Date: <u>Nov. 02, 2018</u>
Witness Name: <u>Jungpyo Kim</u>	
Witness # 2:	
Signature: <u>[Signature]</u>	Date: <u>Nov. 02, 2018</u>
Witness Name: <u>Byung Yoon Kim</u>	

Signature: [Signature]

Date: 11/02/18

Assignor Name: Si-Woo Lee

Witness # 1:	
Signature: <u>[Signature]</u>	Date: <u>Nov. 02, 2018</u>
Witness Name: <u>Byung Yoon Kim</u>	
Witness # 2:	
Signature: <u>[Signature]</u>	Date: <u>Nov. 02, 2018</u>
Witness Name: <u>Jungpyo Kim</u>	